

## High-Frequency NPN Transistor Arrays For Low-Power Applications at Frequencies Up to 1.5GHz

August 1996

### Features

- Gain-Bandwidth Product ( $f_T$ ) ..... >3GHz
- Five Transistors on a Common Substrate

### Applications

- VHF Amplifiers
- VHF Mixers
- Multifunction Combinations-RF/Mixer/Oscillator
- IF Converter
- IF Amplifiers
- Sense Amplifiers
- Synthesizers
- Synchronous Detectors
- Cascade Amplifiers

### Description

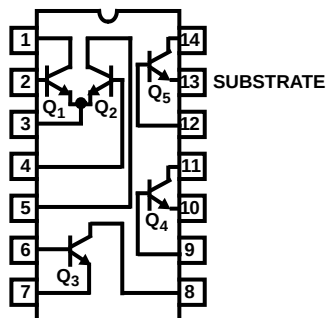
The CA3227 and CA3246 consist of five general purpose silicon NPN transistors on a common monolithic substrate. Each of the transistors exhibits a value of  $f_T$  in excess of 3GHz, making them useful from DC to 1.5GHz. The monolithic construction of these devices provides close electrical and thermal matching of the five transistors.

### Ordering Information

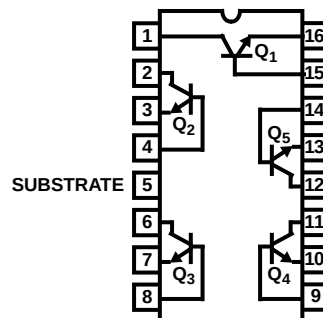
| PART NUMBER (BRAND) | TEMP. RANGE (°C) | PACKAGE                  | PKG. NO. |
|---------------------|------------------|--------------------------|----------|
| CA3227E             | -55 to 125       | 16 Ld PDIP               | E16.3    |
| CA3227M (3227)      | -55 to 125       | 16 Ld SOIC               | M16.15   |
| CA3227M96 (3227)    | -55 to 125       | 16 Ld SOIC Tape and Reel | M16.15   |
| CA3246E             | -55 to 125       | 14 Ld PDIP               | E14.3    |
| CA3246M (3246)      | -55 to 125       | 14 Ld SOIC               | M14.15   |
| CA3246M96 (3246)    | -55 to 125       | 14 Ld SOIC Tape and Reel | M14.15   |

### Pinouts

CA3246  
(PDIP, SOIC)  
TOP VIEW



CA3227  
(PDIP, SOIC)  
TOP VIEW



# CA3227, CA3246

## Absolute Maximum Ratings

|                                                      |      |
|------------------------------------------------------|------|
| Collector-to-Emitter Voltage ( $V_{CE0}$ )           | 8V   |
| Collector-to-Base Voltage ( $V_{CBO}$ )              | 12V  |
| Collector-to-Substrate Voltage ( $V_{CIO}$ , Note 1) | 20V  |
| Collector Current ( $I_C$ )                          | 20mA |

## Operating Conditions

|                   |                |
|-------------------|----------------|
| Temperature Range | -55°C to 125°C |
|-------------------|----------------|

## Thermal Information

|                                                |                      |
|------------------------------------------------|----------------------|
| Thermal Resistance (Typical, Note 2)           | $\theta_{JA}$ (°C/W) |
| 14 Ld PDIP Package                             | 100                  |
| 14 Ld SOIC Package                             | 185                  |
| 16 Ld PDIP Package                             | 90                   |
| 16 Ld SOIC Package                             | 175                  |
| Maximum Power Dissipation (Any One Transistor) | 85mW                 |
| Maximum Junction Temperature (Die)             | 175°C                |
| Maximum Junction Temperature (Plastic Package) | 150°C                |
| Maximum Storage Temperature Range              | -65°C to 150°C       |
| Maximum Lead Temperature (Soldering 10s)       | 300°C                |
| (SOIC - Lead Tips Only)                        |                      |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

## NOTES:

1. The collector of each transistor of these devices is isolated from the substrate by an integral diode. The substrate (Terminal 5 (CA3227) and Terminal 13 (CA3246)) must be connected to the most negative point in the external circuit to maintain isolation between transistors and to provide for normal transistor action.
2.  $\theta_{JA}$  is measured with the component mounted on an evaluation PC board in free air.

## Electrical Specifications $T_A = 25^\circ\text{C}$

| PARAMETER                                     | SYMBOL              | TEST CONDITIONS                                  | MIN                  | TYP  | MAX  | UNITS         |
|-----------------------------------------------|---------------------|--------------------------------------------------|----------------------|------|------|---------------|
| <b>DC CHARACTERISTICS FOR EACH TRANSISTOR</b> |                     |                                                  |                      |      |      |               |
| Collector-to-Base Breakdown Voltage           | $V_{(BR)CBO}$       | $I_C = 10\mu\text{A}$ , $I_E = 0$                | 12                   | 20   | -    | V             |
| Collector-to-Emitter Breakdown Voltage        | $V_{(BR)CEO}$       | $I_C = 1\text{mA}$ , $I_B = 0$                   | 8                    | 10   | -    | V             |
| Collector-to-Substrate Breakdown Voltage      | $V_{(BR)CIO}$       | $I_{C1} = 10\mu\text{A}$ , $I_B = 0$ , $I_E = 0$ | 20                   | -    | -    | V             |
| Emitter-Cutoff-Current (Note 3)               | $I_{EBO}$           | $V_{EB} = 4.5\text{V}$ , $I_C = 0$               | -                    | -    | 10   | $\mu\text{A}$ |
| Collector-Cutoff-Current                      | $I_{CEO}$           | $V_{CE} = 5\text{V}$ , $I_B = 0$                 | -                    | -    | 1    | $\mu\text{A}$ |
| Collector-Cutoff-Current                      | $I_{CBO}$           | $V_{CB} = 8\text{V}$ , $I_E = 0$                 | -                    | -    | 100  | nA            |
| DC Forward-Current Transfer Ratio             | $h_{FE}$            | $V_{CE} = 6\text{V}$                             | $I_C = 10\text{mA}$  | -    | 110  | -             |
|                                               |                     |                                                  | $I_C = 1\text{mA}$   | 40   | 150  | -             |
|                                               |                     |                                                  | $I_C = 0.1\text{mA}$ | -    | 150  | -             |
| Base-to-Emitter Voltage                       | $V_{BE}$            | $V_{CE} = 6\text{V}$ , $I_C = 1\text{mA}$        | 0.62                 | 0.71 | 0.82 | V             |
| Collector-to-Emitter Saturation Voltage       | $V_{CE\text{ SAT}}$ | $I_C = 10\text{mA}$ , $I_B = 1\text{mA}$         | -                    | 0.13 | 0.50 | V             |
| Base-to-Emitter Saturation Voltage            | $V_{BE\text{ SAT}}$ | $I_C = 10\text{mA}$ , $I_B = 1\text{mA}$         | 0.74                 | -    | 0.94 | V             |

## NOTES:

3. On small-geometry, high-frequency transistors, it is very good practice never to take the Emitter Base Junction into reverse breakdown. To do so may permanently degrade the  $h_{FE}$ . Hence, the use of  $I_{EBO}$  rather than  $V_{(BR)EBO}$ . These devices are also susceptible to damage by electrostatic discharge and transients in the circuits in which they are used. Moreover, CMOS handling procedures should be employed.

# CA3227, CA3246

## Electrical Specifications $T_A = 25^\circ\text{C}$ , 200MHz, Common Emitter, Typical Values Intended Only for Design Guidance

| PARAMETER                                               | SYMBOL          |                 | TEST CONDITION                              | TYPICAL VALUES | UNITS   |
|---------------------------------------------------------|-----------------|-----------------|---------------------------------------------|----------------|---------|
| DYNAMIC CHARACTERISTICS FOR EACH TRANSISTOR             |                 |                 |                                             |                |         |
| Input Admittance                                        | Y <sub>11</sub> | b <sub>11</sub> | I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V  | 4              | mS      |
|                                                         |                 | g <sub>11</sub> |                                             | 0.75           | mS      |
| Output Admittance                                       | Y <sub>22</sub> | b <sub>22</sub> | I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V  | 2.7            | mS      |
|                                                         |                 | g <sub>22</sub> |                                             | 0.13           | mS      |
| Forward Transfer Admittance                             | Y <sub>21</sub> | Y <sub>21</sub> | I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V  | 29.3           | mS      |
|                                                         |                 | θ <sub>21</sub> |                                             | -33            | Degrees |
| Reverse Transfer Admittance                             | Y <sub>12</sub> | Y <sub>12</sub> | I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V  | 0.38           | mS      |
|                                                         |                 | θ <sub>12</sub> |                                             | -97            | Degrees |
| Input Admittance                                        | Y <sub>11</sub> | b <sub>11</sub> | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 5V | 4.8            | mS      |
|                                                         |                 | g <sub>11</sub> |                                             | 2.85           | mS      |
| Output Admittance                                       | Y <sub>22</sub> | b <sub>22</sub> | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 5V | 2.75           | mS      |
|                                                         |                 | g <sub>22</sub> |                                             | 0.9            | mS      |
| Forward Transfer Admittance                             | Y <sub>21</sub> | Y <sub>21</sub> | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 5V | 95             | mS      |
|                                                         |                 | θ <sub>21</sub> |                                             | -62            | Degrees |
| Reverse Transfer Admittance                             | Y <sub>12</sub> | Y <sub>12</sub> | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 5V | 0.39           | mS      |
|                                                         |                 | θ <sub>12</sub> |                                             | -97            | Degrees |
| Small Signal Forward Current Transfer Ratio             | h <sub>21</sub> |                 | I <sub>C</sub> = 1mA, V <sub>CE</sub> = 5V  | 7.1            |         |
|                                                         |                 |                 | I <sub>C</sub> = 10mA, V <sub>CE</sub> = 5V | 17             |         |
| TYPICAL CAPACITANCE AT 1MHz, THREE-TERMINAL MEASUREMENT |                 |                 |                                             |                |         |
| Collector-to-Base Capacitance                           | C <sub>CB</sub> |                 | V <sub>CB</sub> = 6V                        | 0.3            | pF      |
| Collector-to-Substrate Capacitance                      | C <sub>CI</sub> |                 | V <sub>CI</sub> = 6V                        | 1.6            | pF      |
| Collector-to-Emitter Capacitance                        | C <sub>CE</sub> |                 | V <sub>CE</sub> = 6V                        | 0.4            | pF      |
| Emitter-to-Base Capacitance                             | C <sub>EB</sub> |                 | V <sub>EB</sub> = 3V                        | 0.75           | pF      |

## Spice Model (Spice 2G.6)

.model NPN

|   |                   |                   |                  |                   |
|---|-------------------|-------------------|------------------|-------------------|
| + | BF = 2.610E + 02  | BR = 4.401E + 00  | IS = 6.930E - 16 | RB = 130.0E + 00  |
| + | RC = 1.000E + 01  | RE = 7.396E - 01  | VA = 6.300E + 01 | VB = 2.208E + 00  |
| + | IK = 1.000E - 01  | ISE = 1.87E - 14  | NE = 1.653E + 00 | IKR = 1.000E - 02 |
| + | ISC = 9.25E - 14  | NC = 1.333E + 00  | TF = 1.775E - 11 | TR = 1.000E - 09  |
| + | CJS = 1.800E - 12 | CJE = 1.010E - 12 | PE = 8.350E - 01 | ME = 4.460E - 01  |
| + | CJC = 9.100E - 13 | PC = 3.850E - 01  | MC = 2.740E - 01 | KF = 0.000E + 00  |
| + | AF = 1.000E + 00  | EF = 1.000E + 00  | FC = 5.000E - 01 | PJS = 5.410E - 01 |
| + | MJS = 3.530E - 01 | RBM = 30.00       | RBV = 100        | IRB = 0.00        |

Please Note: No measurements have been made to model the reverse AC operation (tr is an estimation).

# Typical Performance Curves

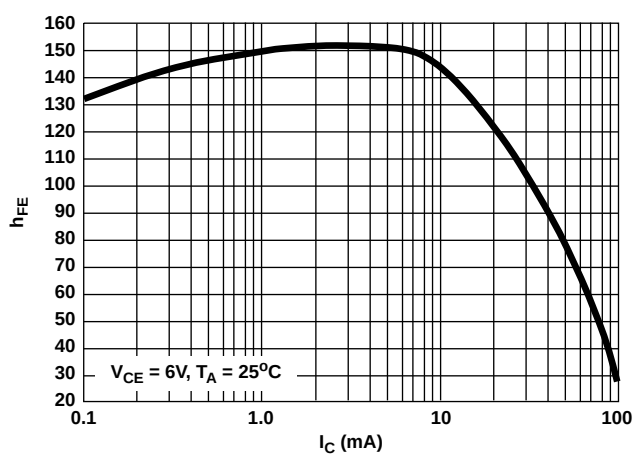
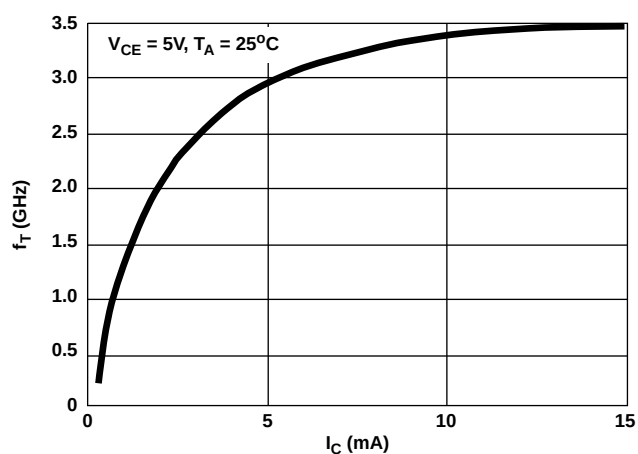
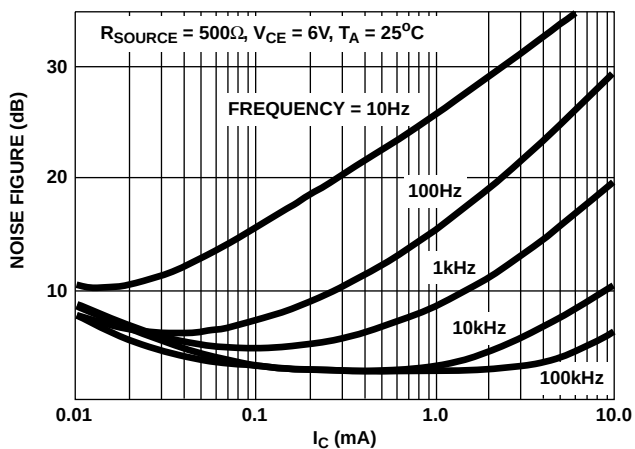
FIGURE 1.  $h_{FE}$  vs COLLECTOR CURRENTFIGURE 2.  $f_T$  vs COLLECTOR CURRENT

FIGURE 3. NOISE FIGURE vs COLLECTOR CURRENT

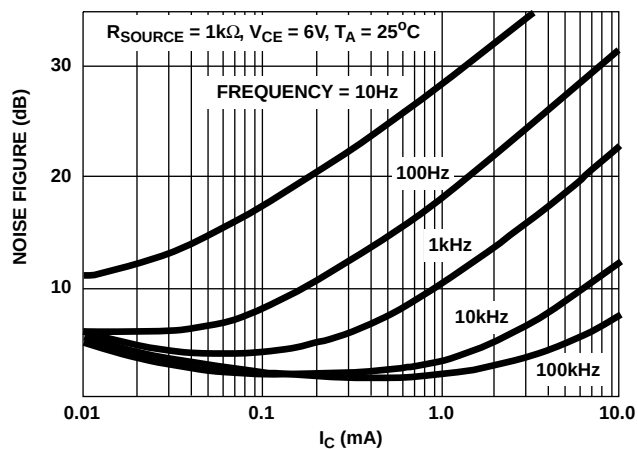


FIGURE 4. NOISE FIGURE vs COLLECTOR CURRENT

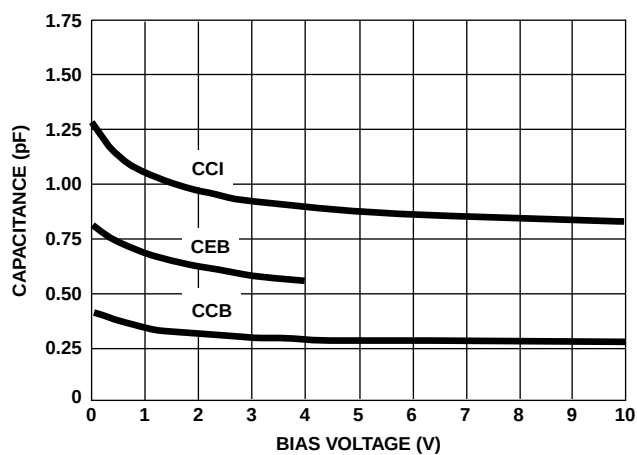


FIGURE 5. CAPACITANCE vs BIAS VOLTAGE

## Die Characteristics

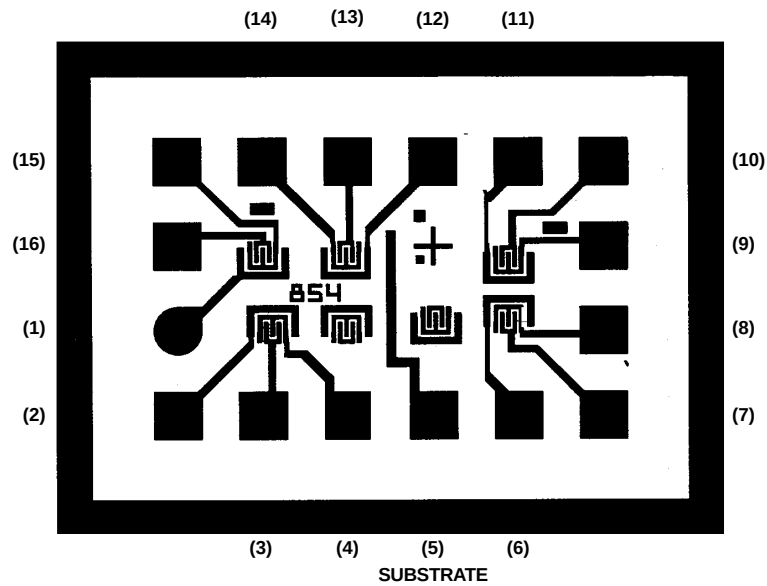
### DIE DIMENSIONS:

46 mils x 32 mils - CA3227

47 mils x 33 mils - CA3246

## Metallization Mask Layout

CA3227



CA3246

